

1.0X0.5X0.2mm (0402)SMD CHIP LED LAMP

Part Number: APG1005SEC/E-T

Hyper-Red

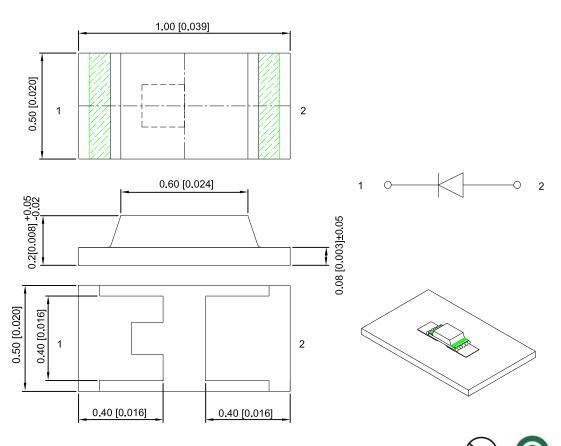
Features

- 1.0mmX0.5mm SMD LED, 0.2mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 4000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper-Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
ADC4005050/5 T	Hyper-Red (AlGalnP)	Mater Clear	55	127	120°
APG1005SEC/E-T		Water Clear	*20	*75	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper-Red	632		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper-Red	624		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper-Red	20		nm	IF=20mA
VF [2]	Forward Voltage	Hyper-Red	2.0	2.4	V	IF=20mA
lr	Reverse Current	Hyper-Red		10	uA	VR=5V

Notes:

- Wavelength: +/-1nm.
 Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

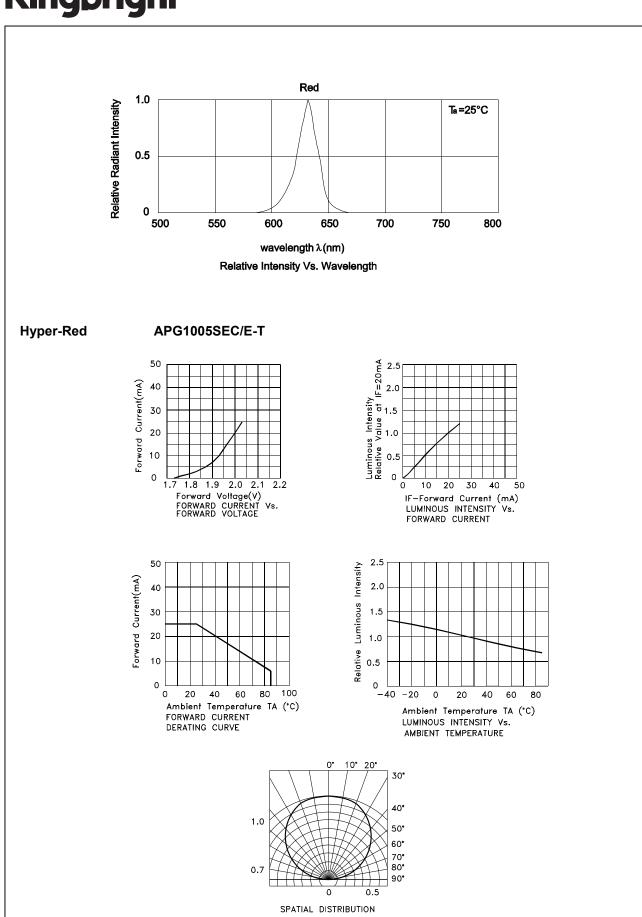
Absolute Maximum Ratings at TA=25°C

Parameter	neter Values				
Power dissipation	60	mW			
DC Forward Current	25	mA			
Peak Forward Current [1]	120	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C	-40°C To +85°C			
Storage Temperature	-40°C To +85°C	-40°C To +85°C			

Notes:

- 1.1/10 Duty Cycle, 0.1ms Pulse Width.
 Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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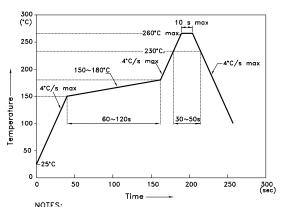


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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

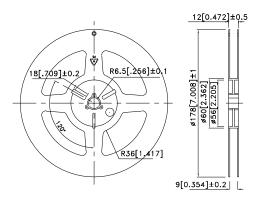
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

 3.Number of reflow process shall be 2 times or less.

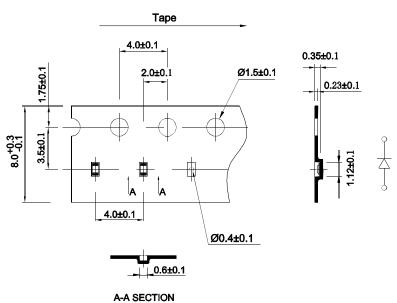
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Mask open area ratio:80% Mask thickness:80~100um

Reel Dimension



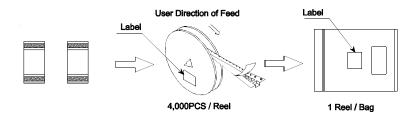
Tape Dimensions (Units: mm)

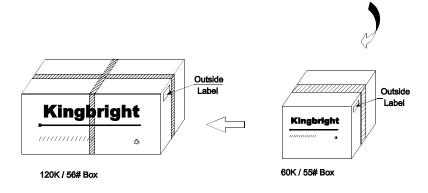


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PACKING & LABEL SPECIFICATIONS

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